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Part Number: [0430450212](#)
Status: **Active**
Overview: [Micro-Fit Connector System](#)
Description: Micro-Fit 3.0 Vertical Header, 3.00mm Pitch, Dual Row, 2 Circuits, with PCB Polarizing Peg, Tin, Glow-Wire Capable, Black

Documents:

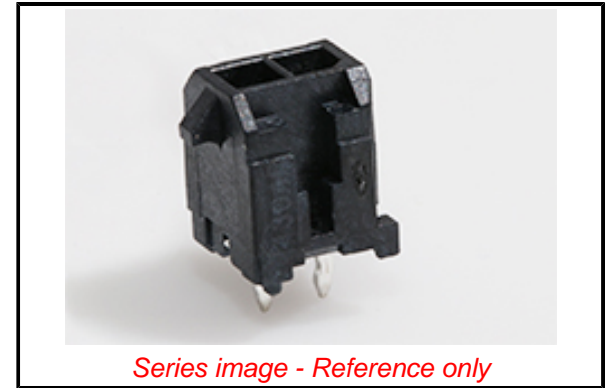
| | |
|---|--|
| 3D Model (PDF) | Test Summary TS-43045-001-001 (PDF) |
| Drawing (PDF) | Test Summary TS-46235-001-001 (PDF) |
| 3D Model | Datasheet (PDF) |
| Product Specification PS-43045-001 (PDF) | RoHS Certificate of Compliance (PDF) |
| Packaging Specification PK-70873-0314-001 (PDF) | Product Literature (PDF) |
| Test Summary 430450004-TS-000 (PDF) | |

Agency Certification

| | |
|-----|---------|
| CSA | LR19980 |
| UL | E29179 |

General

| | |
|----------------|--|
| Product Family | PCB Headers |
| Series | 43045 |
| Application | Power, Wire-to-Board |
| Comments | <p>High Temperature Square Pin Offset Through Hole Mounting Solder Type<P><P>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13.. b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <P><P> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard IEC 60695-2-11 and any applicable product end-use standard(s). <P> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options. High Temperature Square Pin Offset Through Hole Mounting Solder Type<P><P>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13.. b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <P><P> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard</p> |



Series image - Reference only

EU ELV

Not Relevant

EU RoHS

Compliant

REACH SVHC

Not Contained Per - ED/71/2019 (16 July 2019)

Halogen-Free

Status

Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

ELV

RoHS Phthalates

China RoHS

Green Image

Not Relevant

Not Contained

Search Parts in this Series

[43045 Series](#)

Mates With

Micro-Fit 3.0 Receptacle Housing [43025](#)

Micro-Fit 3.0 Cable Assembly [245132](#)

Micro-Fit 3.0 TPA Receptacle Housing [172952](#)

IEC 60695-2-11 and any applicable product end-use standard(s). <P> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options. """"""""

Micro-Fit Connector System

Overview
Product Name
UPC

Micro-Fit 3.0
800754370042

Physical

| | |
|--------------------------------|--------------------------------|
| Breakaway | No |
| Circuits (Loaded) | 2 |
| Circuits (maximum) | 2 |
| Color - Resin | Black |
| Durability (mating cycles max) | 30 |
| Flammability | 94V-0 |
| Glow-Wire Capable | Yes |
| Mated Height | 17.64mm |
| Material - Metal | Brass |
| Material - Plating Mating | Tin |
| Material - Plating Termination | Tin |
| Material - Resin | High Temperature Thermoplastic |
| Net Weight | 0.482/g |
| Number of Rows | 2 |
| Orientation | Vertical |
| PCB Locator | Yes |
| PCB Retention | Yes |
| PCB Thickness - Recommended | 1.60mm |
| Packaging Type | Tray |
| Pitch - Mating Interface | 3.00mm |
| Plating min - Mating | 0.254µm |
| Polarized to PCB | Yes |
| Shrouded | Fully |
| Stackable | No |
| Surface Mount Compatible (SMC) | Yes |
| Temperature Range - Operating | -40° to +105°C |
| Termination Interface: Style | Through Hole - Kinked Pin |

Electrical

| | |
|-------------------------------|------|
| Current - Maximum per Contact | 8.5A |
| Voltage - Maximum | 600V |

Solder Process Data

| | |
|--|----------|
| Duration at Max. Process Temperature (seconds) | 030 |
| Lead-free Process Capability | SMC&WAVE |
| Max. Cycles at Max. Process Temperature | 003 |
| Process Temperature max. C | 260 |

Material Info

Reference - Drawing Numbers

| | |
|-------------------------|---|
| Packaging Specification | PK-70873-0314-001 |
| Product Specification | PS-43045-001 |
| Sales Drawing | SD-43045-005 |
| Symbol/Footprint Data | SYM-43045-0212, SYM-43045-021X |
| Test Summary | 430450004-TS-000, TS-43045-001-001, TS-46235-001-001 |

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